

UV-LED parallel light exposure machine

Mainly used in PCB printed circuit board and FPC flexible printed circuit pole, LCD display and other fields

MANUAL MACHINE For inner layer, outer layer and solder mask



UV-LED parallel light exposure machine

High Efficiency
Power Savings
Easy Maintenance
Cost Effective
Environmental Friendly
LED Technology



Technical Specifications

Model	KST-E7070-BLZX	KST-E10070-BLZX	KST-E13070-BLZX
Parameters			
Exposure Area	700x700mm ²	1000x700mm ²	1250x700mm ²
Panel Thickness	0.075-3.2mm	0.075-3.2mm	0.075-3.2mm
Light Source	LED	LED	LED
Frame Style	Mylar/Glass	Mylar/Glass	Mylar/Glass
Uniformity	>85%	>85%	>85%
Track/Gap Resolution	75um/50um	75um/50um	75um/50um
Control System	IO+IIMI+PLC	IO+IIMI+PLC	IO+IIMI+PLC
Machine Dimensions	2040x1280x1870	2500x1630x1750	2800x2070x1750
Machine Weight	800kg	1000kg	1100kg
Power Requirements	20A,380V, 10,50HZ	30A,380V, 10,50I-HZ	35A,380VJ0,50I-HZ
Environments	20±3 ° (Humidity:55±5%	20±3 ° (Humidity:55±5%	20±3 ° (Humidity:55±5%

SEMI-AUTOMATIC For outer layer and solder mask

KST-SA6457S-W

Outer layer

KST-SA6457-F

Solder mask

